PAT-NO:

JP402027615A

DOCUMENT-IDENTIFIER: JP 02027615 A

TITLE:

INPUT AND OUTPUT CABLE FOR EXTREMELY LOW

TEMPERATURE

INTEGRATED CIRCUIT

PUBN-DATE:

January 30, 1990

INVENTOR - INFORMATION:

NAME

NAKAGAWA, KOICHI

ASSIGNEE - INFORMATION:

COUNTRY

NIPPON TELEGR & TELEPH CORP <NTT>

N/A

APPL-NO:

JP63178451

APPL-DATE:

July 18, 1988

INT-CL (IPC): H01B012/06, H01L039/06

US-CL-CURRENT: 174/15.4

## ABSTRACT:

PURPOSE: To prevent any trouble on contacts associated with heat

under an extremely low temperature by utilizing a vertically orientated polymer

insulating layer as an insulating layer, and absorbing a heat strain due to a

difference in a linear expansion among foreign materials of a signal wire, the

insulating layer and a grounding conductor.

CONSTITUTION: The first vertically orientated polymer insulating layer 5

comprising a signal wire (copper) 2, the first grounding conductor (copper) 3,

the second grounding conductor (copper) 4 and poly-oxymethylene, and the second

vertically orientated polymer insulating layer 6 comprising polyoxymethylene

are prepared. Then, an insulated conductor is formed by lamination by epoxy

glue 7 so that the vertically orientated polymer insulating layers 5 and 6 may

touch the signal wire 2. In the vertically orientated polymer insulating

layers 5 and 6 a polymer crystalline granule block of which a molecule axis is

orientated perpendicular to a surface of the grounding conductor intervenes

between a surface that correlative signal wires are lined in parallel and the

grounding conductor. Due to a spacing existing in a boundary of a crystalline

granule within a surface paralleled to the grounding conductor, the heat strain

may be absorbed. Accordingly any trouble on contacts associated with the heat

contraction under the extremely low temperature may be prevented.

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PAT-NO:

JP362091533A

DOCUMENT-IDENTIFIER:

JP 62091533 A

TITLE:

METHOD OF BONDING POLYOXYMETHYLENE

PUBN-DATE:

April 27, 1987

INVENTOR - INFORMATION:

NAME

HIROSHIMA, MASAHIRO

ASSIGNEE - INFORMATION:

NAME

COUNTRY

ASAHI CHEM IND CO LTD

N/A

APPL-NO:

JP60229846

APPL-DATE:

October 17, 1985

INT-CL (IPC): C08J005/12, B29C065/52

US-CL-CURRENT: 156/272.2

## ABSTRACT:

PURPOSE: To bond polyoxymethylene firmly to each other or to other material,

by irradiating its surface with electron beams and bonding it with an adhesive.

CONSTITUTION: In bonding polyoxymethylene to each other or to other

material, its surface is previously irradiated with electron beams and then

bonded by using an adhesive. When irradiating with electron beams, the tensile

strength is affected by the dose. Particularly, when polyoxymethylene is

irradiated at a dose exceeding 5Mrad, the tensile strength is extremely

lowered. Hence, it is desirable that the dose is 1Mrad or below.

Polyoxymethylene which has been irradiated with electron beams can be bonded

with a conventional cyanoacrylate adhesive or an **epoxy** adhesive.

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